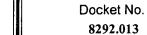
ON TRANSMITTAL LETTER

(Large Entity)





Transmitted herewith for filing under 35 U.S.C. 111 and 37 C.F.R. 1.53 is the patent application of:

SATO, Takaya; SHIMIZU, Tatsuo

CC:

For: MULTI-LAYER ELECTRODE STRUCTURE AND METHOD OF MANUFACTURING SAME

	Enclosed are:							
	Certificate of Mailing with Express Mail Mailing Label No.							
	■ .12□ A certified copy of	sheets of o	drawings.	application.				
	☐ Declaration	a □ Signed.	Unsigned.	аррисацоп.				
	☐ Power of Attorney							
☐ Information Disclosure Statement ☐ Preliminary Amendment								
9	☑ Other: Spec., Claims & Abstract							
, J' 19***		CLAIMS AS FILED						
india il	For	#Filed	#Allowed	#Extra		Rate	Fee	
Junit Jen	Total Claims	53	- 20 =	33	x	\$18.00	\$594.00	
2	Indep. Claims	19	- 3 =	16	x	\$80.00	\$1,280.00	
I il mari	Multiple Dependent Claims (check if applicable)						\$0.00	
Tradi		<u> </u>				BASIC FEE	\$710.00	
						TOTAL FILING FEE	\$2,584.00	
4	☐ A check in the amo	A check in the amount of to cover the filing fee is enclosed.						
	☐ The Commissioner is hereby authorized to charge and credit Deposit Account No.							
	as described below. A duplicate copy of this sheet is enclosed. ☐ Charge the amount of as filing fee.							
	-							
	☐ Credit any overpayment.☐ Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17.							
	☐ Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance,							
pursuant to 37 C.F.R. 1.311(b).								
My U								
Dated: February 16, 2001 Signature								
		Matthew W. Stavish						
Reg No. 36,286						•		
						renato, Longacre & White	e	
					6550 Rock Spring Drive Suite 240			

Bethesda, MD 20817 (301)896-0600